#### QSFP/QSFP+

TE Internal #: 2174754-2

QSFP+, Cage Assembly, Sealable, Signal, Operating Temperature

Range -55 – 105 °C [-67 – 221 °F], Data Rate (Max) 14 Gb/s, 4 Ports

View on TE.com >



Connectors > Pluggable IO Connectors & Cages



Form Factor: QSFP+

Pluggable I/O Product Type: Cage Assembly

Sealable: Yes

Circuit Application: Signal

Operating Temperature Range: -55 - 105 °C [ -67 - 221 °F ]

#### **Features**

# **Product Type Features**

Cage Type	Ganged
Thermal Accessory Type Included	Heat Sink
Form Factor	QSFP+
Pluggable I/O Product Type	Cage Assembly
Sealable	Yes

#### **Configuration Features**

Number of Rear EONs per Port Column	1
Number of Ports	4
Port Matrix Configuration	1 × 4

#### **Electrical Characteristics**

Data Rate (Max)	14 Gb/s

#### **Body Features**

Heat Sink Style	Pin
Heat Sink Finish	Anodized Black
Heat Sink Height	6.5 mm[.256 in]
Heat Sink Height Class	SAN

#### **Contact Features**

PCB Contact Termination Area Plating Material Tin	
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Termination Method to PCB	Through Hole - Press-Fit

Termination Post & Tail Length 2.2 mm[.086 in]

### **Housing Features**

Cage Material	Nickel Silver

#### **Dimensions**

PCB Thickness (Recommended) 1.45 mm[.057 in]	PCB Thickness (Recommended)	1.45 mm[.057 in]
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# **Usage Conditions**

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

# Operation/Application

Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly
Circuit Application	Signal

# **Industry Standards**

UL Flammability Rating	UL 94V-0	
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# **Packaging Features**

Packaging Method	Box & Tray	
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#### Other

Included Lightpipe	No
EMI Containment Feature Type	Elastomeric Gasket

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability



#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

# **Compatible Parts**



TE Part # 2829040-7 QSFP IB EDR, 26AWG, 2.0M



TE Part # 2202165-5 QSFP TO QSFP, 26AWG, FDR, 5.0 METER



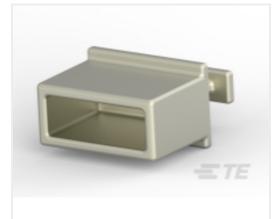
TE Part # 2829040-8 QSFP IB EDR, 26AWG, 3.0M



TE Part # 2202165-4 QSFP TO QSFP, 26AWG, FDR, 4.0 METER



TE Part # 2053453-5 C/A, QSFP TO 4XSFP+, 4.0M



TE Part # 1888810-2 EMI/Dust Cover,XFP And QSFP



TE Part # 2829040-2 QSFP IB EDR, 33AWG, 1.0M



TE Part # CAT-C11-H5011142 QSFP to QSFP I/O Cable Assembly: 33 AWG



TE Part # 1-2053638-6 C/A, QSFP, 0.5M, P1-P2, UNEQUALIZED



TE Part # 2821033-8 QSFP TO [4]SFP+, 28G, 1M, 33AWG



TE Part # 2829040-4 QSFP IB EDR, 30AWG, 1.0M



TE Part # 2110819-1

QSFP+ Enh EVERCLEAR PT Conn





TE Part # 2829040-6 QSFP IB EDR, 30AWG, 2.0M

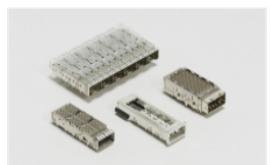




# Also in the Series | QSFP/QSFP+



Pluggable I/O Cable Assemblies(13)



Pluggable IO Connectors & Cages(154)



QSFP, QSFP+ & zQSPF+(154)

# Customers Also Bought



TE Part #2057042-5 1x3 QSFP Kit Assy Lp&HS, SAN



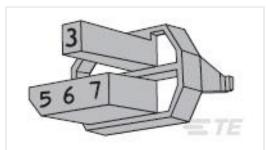
TE Part #2127932-1 C/A, SFP+, GENERIC, 0.5M



TE Part #2057183-4 1x4 QSFP Kit Assy, LP&HS, PCI



TE Part #2170864-1 Z-PACK/B F-HDR. 95P, EON



TE Part #6-100526-9
Z-PACK F.CODING KEY



TE Part #6368077-2 2X4 OFFSET STK MJ,SHLD,RJ45,W /GND



TE Part #2057042-8 1x3 QSFP Kit Assy LP&HS, Networking



TE Part #2170863-1
Z-PACK/B F-HDR 110P, EON



TE Part #3-2176306-8 RP 1E 0.1W 2K8 0.1% 25PPM 5K RL





### **Documents**

### **Product Drawings**

1x4 QSFP Kit Assy Bhnd Bzl,w/gasket,SAN

English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2174754-2\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2174754-2\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2174754-2\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English